



PDFNWB3.3x3.3-8L Plastic-Encapsulate MOSFETS

AB25N04

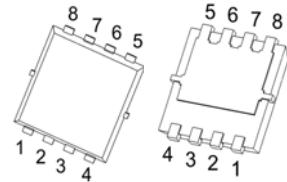
N-Channel Power MOSFET

V _{(BR)DSS}	R _{DS(ON)TYP}	I _D
40V	7.2mΩ@10V	25A
	10mΩ@4.5V	

DESCRIPTION

The AB25N04 uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications

PDFNWB3.3x3.3-8L



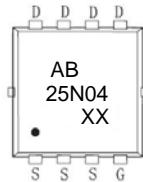
FEATURES

- High Power and current handing capability
- Load switch
- High density cell design for ultra low R_{DS(ON)}
- Lead free product is acquired
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATIONS

- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply
- Power management

MARKING

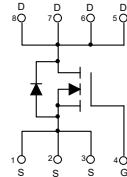


AB25N04 = Part No.

Solid dot = Pin1 indicator

XX = Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (T_J=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D ^①	25	A
Pulsed Drain Current	I _{DM} ^{①②}	100	A
Single Pulsed Avalanche Energy	E _{AS} ^③	141	mJ
Power Dissipation	P _D ^①	52	W
Thermal Resistance from Junction to Ambient	R _{θJA} ^⑥	90	°C/W
Thermal Resistance from Junction to Case	R _{θJC} ^①	2.4	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{stg}	-55 ~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10s)	T _L	260	°C

MOSFET ELECTRICAL CHARACTERISTICS

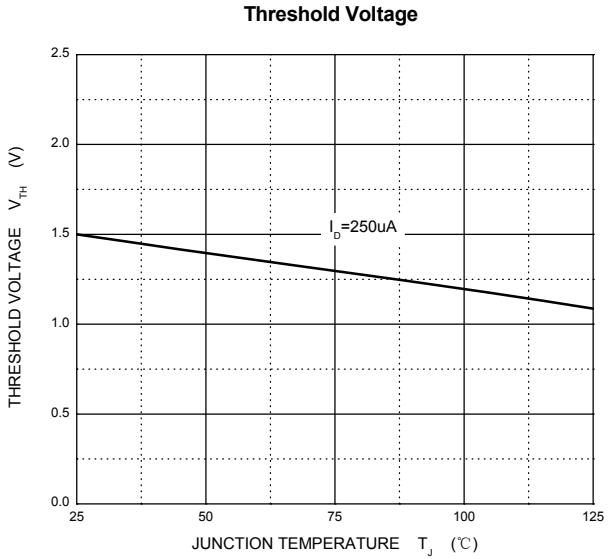
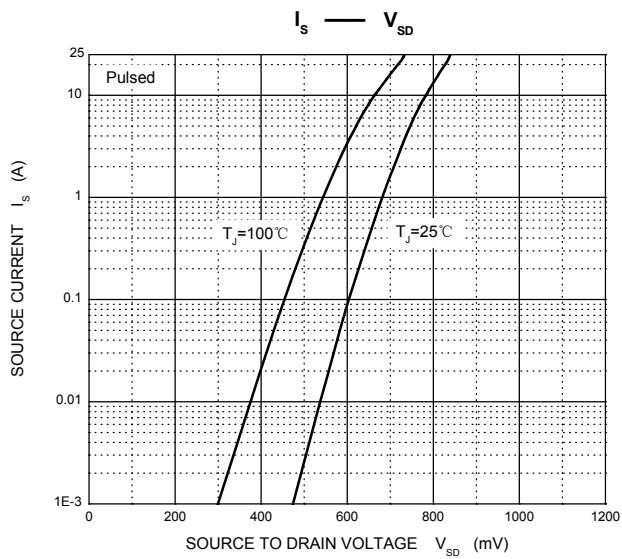
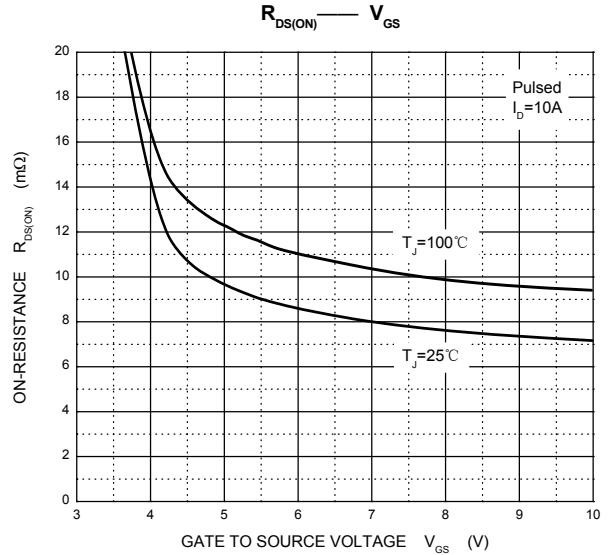
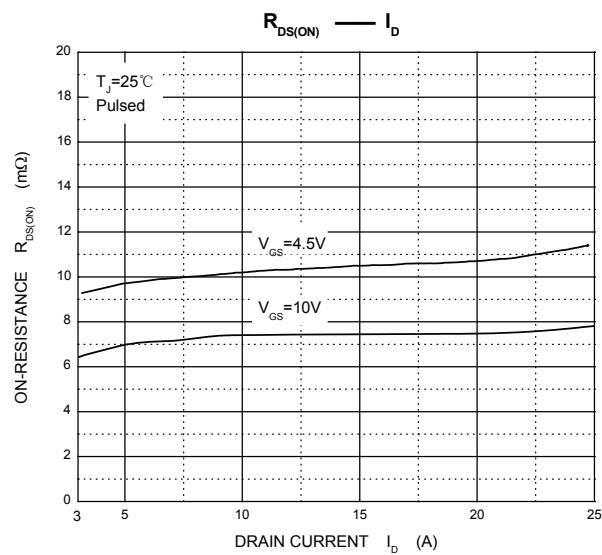
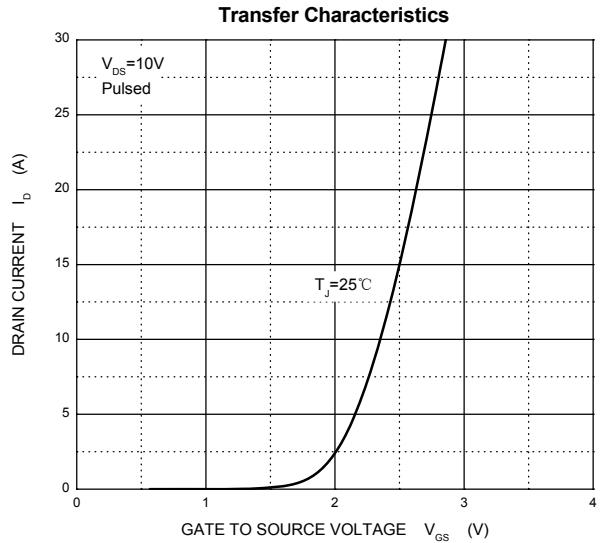
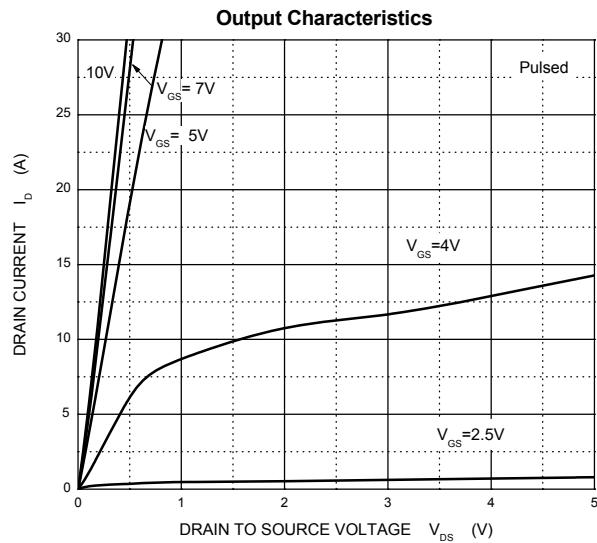
$T_J=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(\text{BR}) \text{ DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			± 100	nA
On characteristics^④						
Gate-threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.0	1.5	2.5	V
Static drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		7.2	9.5	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 10\text{A}$		10	16	$\text{m}\Omega$
Forward transconductance	g_{fs}	$V_{\text{DS}} = 5\text{V}, I_D = 20\text{A}$		36		S
Dynamic characteristics^⑤						
Input capacitance	C_{iss}	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1980		pF
Output capacitance	C_{oss}			155		
Reverse transfer capacitance	C_{rss}			125		
Switching characteristics^⑥						
Total gate charge	Q_g	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		48		nC
Gate-source charge	Q_{gs}			5.5		
Gate-drain charge	Q_{gd}			12.3		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = 25\text{V}, I_D = 14\text{A}, V_{\text{GS}} = 10\text{V}, R_G = 3\Omega$		12		ns
Turn-on rise time	t_r			35		
Turn-off delay time	$t_{\text{d}(\text{off})}$			48		
Turn-off fall time	t_f			11		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	$V_{\text{SD}}^{④}$	$V_{\text{GS}} = 0\text{V}, I_S = 10\text{A}$			1.2	V
Continuous drain-source diode forward current	$I_S^{①}$				25	A
Pulsed drain-source diode forward current	$I_{\text{SM}}^{①②}$				100	A

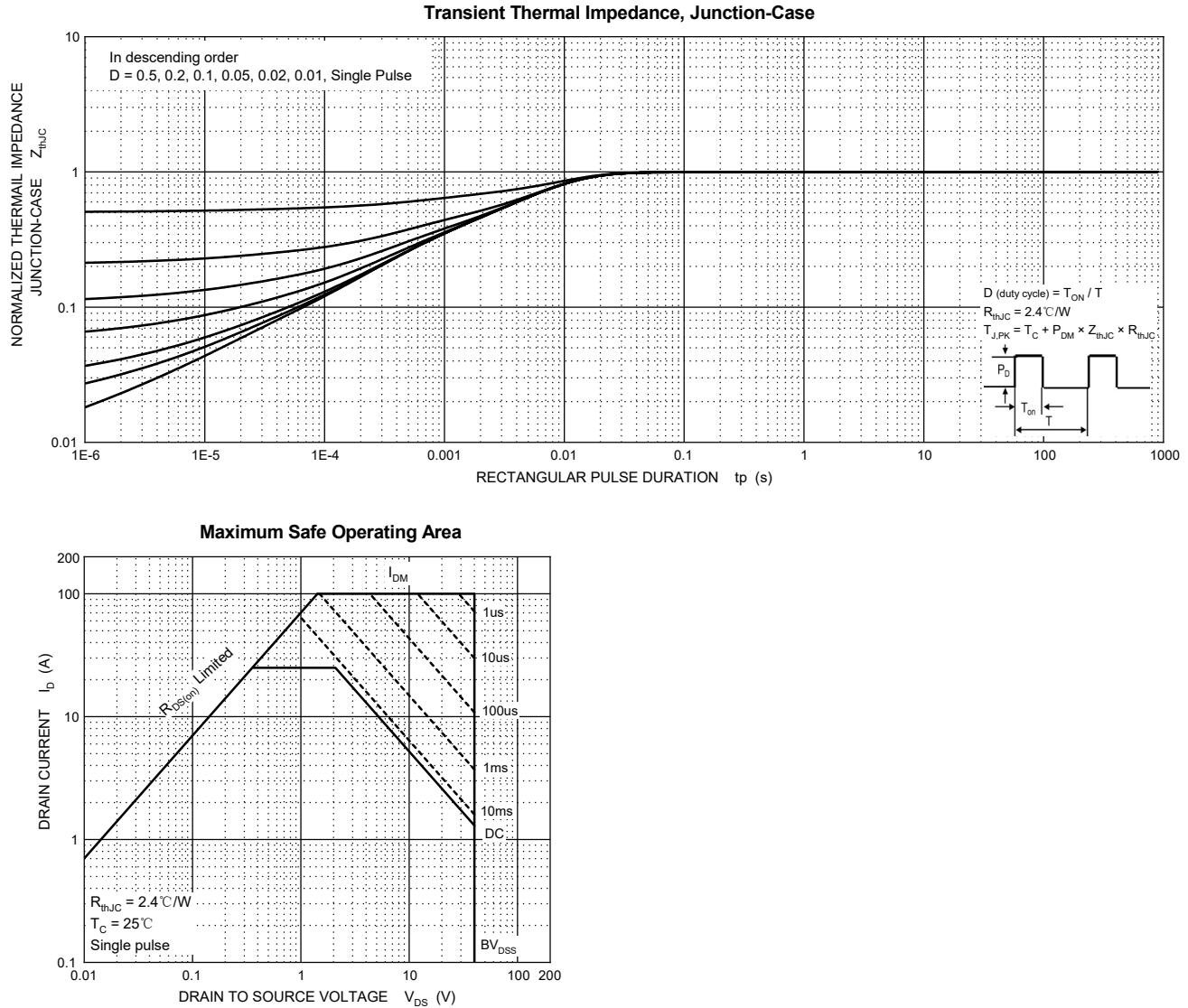
Notes:

1. $T_c = 25^\circ\text{C}$ Limited only by maximum temperature allowed.
2. $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$.
3. EAS condition: $V_{\text{DD}} = 15\text{V}, L = 0.1\text{mH}, R_g = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
4. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
5. Guaranteed by design, not subject to production.
6. Device mounted on 1 in² FR-4 board with 2oz. single-sided Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

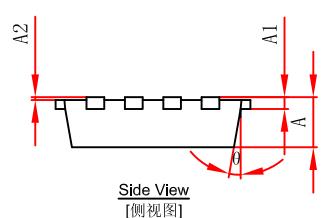
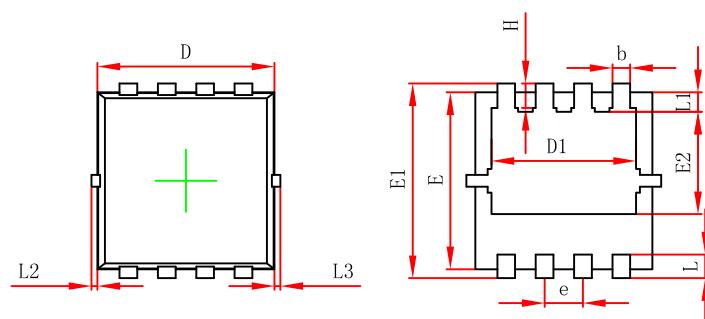
Typical Characteristics



Typical Characteristics



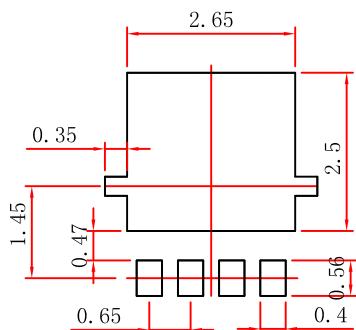
PDFNWB3.3x3.3-8L Package Outline Dimensions



Bottom View
[背视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°

PDFNWB3.3x3.3-8L Suggested Pad Layout

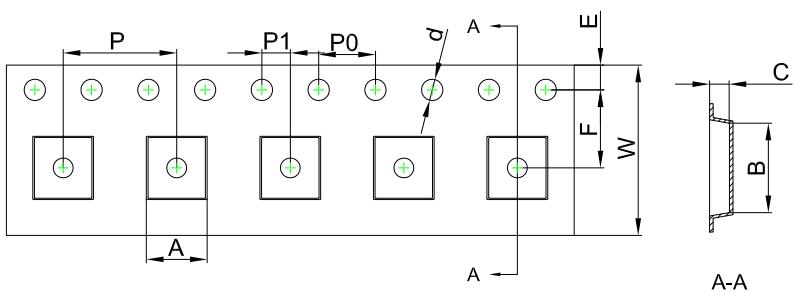


Note:

1. Controlling dimension:in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

PDFNWB3.3×3.3-8L Tape and Reel

PDFNWB3.3×3.3-8L Embossed Carrier Tape



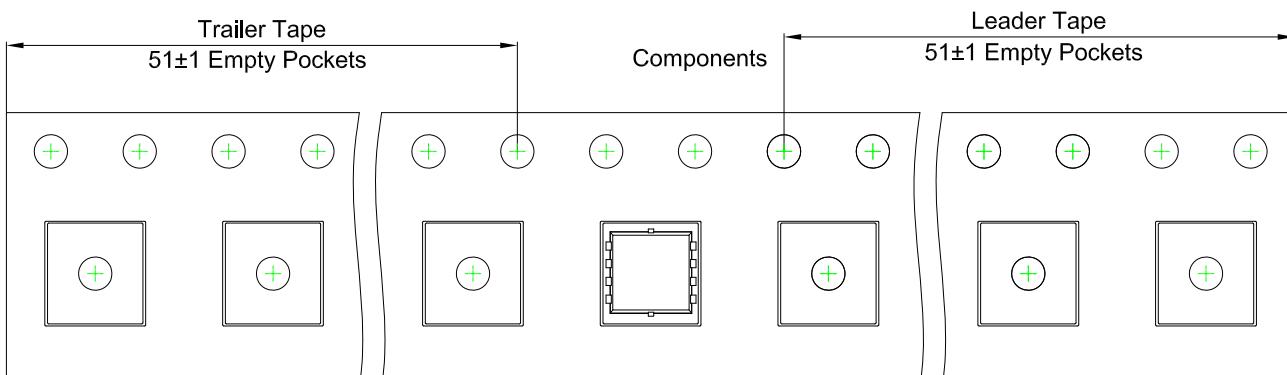
Packaging Description:

PDFNWB3.3×3.3-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

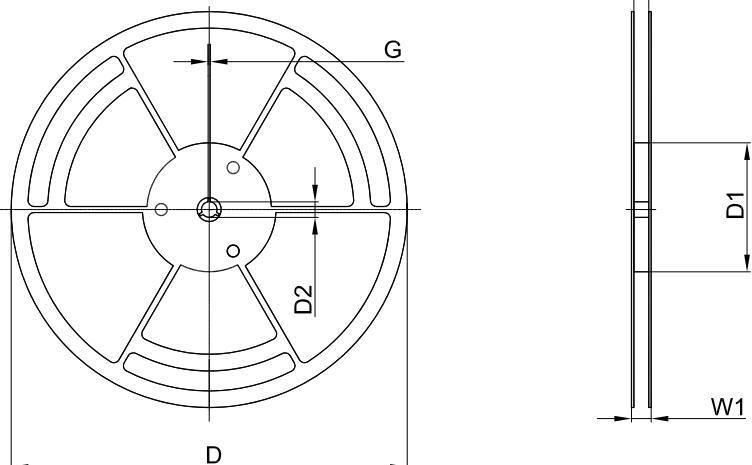
Dimensions are in millimeter

Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB3.3x3.3-8L	3.55	3.55	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFNWB3.3×3.3-8L Tape Leader and Trailer



PDFNWB3.3×3.3-8L Reel



Dimensions are in millimeter

Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365